AIDW12S65C5

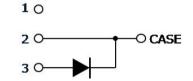


650V/12A Silicon Carbide Schottky Diode in TO247-3

Features

- Revolutionary semiconductor material Silicon Carbide
- Benchmark switching behavior
- No reverse recovery/ No forward recovery
- Temperature independent switching behavior
- High surge current capability
- Pb-free lead plating; RoHS compliant
- Junction Temperature range from -40°C to 175°C
- System efficiency improvement over Si diodes
- System cost / size savings due to reduced cooling requirements
- Enabling higher frequency / increased power density solutions
- Higher system reliability due to lower operating temperatures
- Reduced EMI





RoHS

Infineon

Potential Applications

- Traction inverter
- Booster / DCDC Converter
- On board Charger / PFC

Product Validation

"Qualified for Automotive Applications. Product Validation according to AEC-Q100/101"

Description

The 5th Generation CoolSiC[™] Automotive Schottky Diode represents Infineon leading edge technology for Silicon Carbide Schottky Barrier diodes. Thanks to a compact design and a technology based on thin wafers, this family of products shows improved efficiency over all load conditions resulting from both its thermal characteristics and low figure of merit (Qc x Vf). This product family has been designed to complement Infineon's IGBT and CoolMOS[™] portfolio. This ensures meeting the most stringent application requirements in the 650V voltage class.

🔁 Green

| Product Information | | | | |
|---------------------|---------------|--|--|--|
| Ordering Code | AIDW12S65C5 | | | |
| Marking | AD1265C5 | | | |
| Package | PG-TO247-3-41 | | | |
| SP Number | SP001725222 | | | |

| Parameter | Value/Unit | | | | |
|---|------------|--|--|--|--|
| V _{DC,max} | 650 V | | | | |
| I _F ; T _C < 133 ℃ | 12 A | | | | |
| $Q_{\rm C}; V_{\rm R}$ = 400 V | 18 nC | | | | |
| $E_{C}; V_{R} = 400 V$ | 4.1 μJ | | | | |
| T _{j,max} | 175 °C | | | | |

| Pin | Definition |
|-------------|------------|
| Pin 2, case | Cathode |
| Pin 3 | Anode |



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Maximum Ratings

1 Maximum Ratings

Table 1Maximum ratings1

| Parameter | Symbol | Value | Unit |
|---|--------------------|--------------|------------------|
| Repetitive peak reverse voltage | V _{RRM} | 650 | V |
| Continuous forward current for R _{thJC,max} T _C = 133 °C, D=1 | I _F | 12 | А |
| Surge non-repetitive forward current, sine halfwave T _C = 25°C, t _p =10ms T _C = 150°C, t _p =10ms | I _{F,SM} | 71 56 | A |
| Non-repetitive peak forward current T _C = 25°C, t _p =10µs | I _{F,max} | 505 | А |
| i ² t value T _C = 25°C, t _p =10ms T _C = 150°C, t _p =10ms | ∫i ² dt | 25.4 15.7 | A ² s |
| Diode dv/dt ruggedness V _R =0480V | dv/dt | 100 | V/ns |
| Power dissipation T _c = 25°C | P _{tot} | 76 | W |
| Operating temperature | Tj | -40175 | °C |
| Storage temperature | T _{stg} | -55150 | °C |
| ESD | | | |
| Human body model, R= 1.5 kΩ, C = 100 pF Charged device model | | 8 2 | kV |
| Soldering temperature, wavesoldering only allowed at leads, 1.6mm (0.063 in.) from case for 10 s | T _{sold} | 260 | °C |
| Mounting Torque (M3 and M4 screws) | | 70 | Ncm |



Thermal Characteristics

2 Thermal Characteristics

Table 2Thermal Characteristics1

| Darameter | Symbol | Values | | | 11 | Noto /Tost oon didion |
|---|------------|--------|------|------|------|-----------------------|
| Parameter | | Min. | Тур. | Max. | Unit | Note/Test condition |
| Thermal resistance, junction–case ² | R_{thJC} | - | 1.5 | 2.0 | K/W | |
| Thermal resistance, junction-ambient ² | R_{thJA} | - | I | 62 | K/W | |



Electrical Characteristics

3 Electrical Characteristics

Table 3Static Characteristics

| Deremeter | Symbol | Values | | | Unit | Noto /Test condition |
|------------------------------------|-----------------|--------|------|------|------|---|
| Parameter | | Min. | Тур. | Max. | Unit | Note/Test condition |
| DC blocking voltage | V _{DC} | 650 | - | - | | T _j = 25°C, I _R = 0.07 mA |
| Diode forward voltage ³ | V _F | - | 1.5 | 1.7 | v | T _j = 25°C, I _F = 12 A |
| | | - | 1.8 | 2.1 | | T _j = 150°C, I _F = 12 A |
| Reverse current | I _R | - | 2 | 70 | | V _R = 650 V, T _j = 25 °C |
| | | - | 14 | - | μA | V _R = 650 V, T _j = 150 °C |

Table 4Dynamic Characteristics at Tj=25°C unless noted otherwise

| Parameter | Symbol | Values | | | Unit | Note /Test condition |
|-------------------------|--------|--------|------|------|------|---|
| Falanietei | | Min. | Тур. | Max. | Unit | Note/Test condition |
| Total capacitive charge | Qc | - | 18 | - | nC | $V_R = 400 \text{ V}, \text{ di/dt} = 200 \text{ A/}\mu\text{s},$ $I_F \leq I_{F,MAX}, T_j = 150 \text{ °C}$ |
| Total capacitance | С | - | 363 | - | рF | V _R = 1 V, f = 1 MHz |
| | | - | 47 | - | | V _R = 300 V, f= 1 MHz |
| | | - | 46 | - | | V _R = 600 V, f= 1 MHz |

Footnotes:

¹ The parameter is not subject to production test- verified by design/characterization.

² Rth, JC defined as per JESD-51-14. Rth, JA defined as per JESD-51-2.

³ Only the value at 25°C is subject to production test. The value at 150°C is only verified by design/characterization.



Electrical Characteristics Diagrams

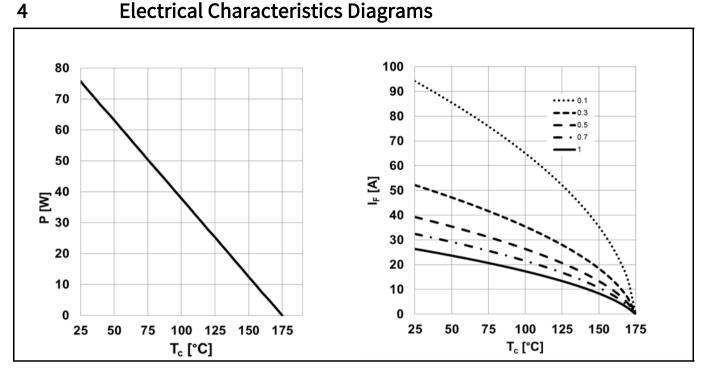
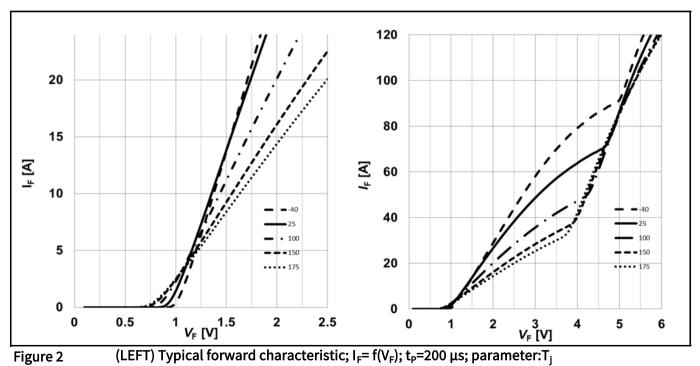


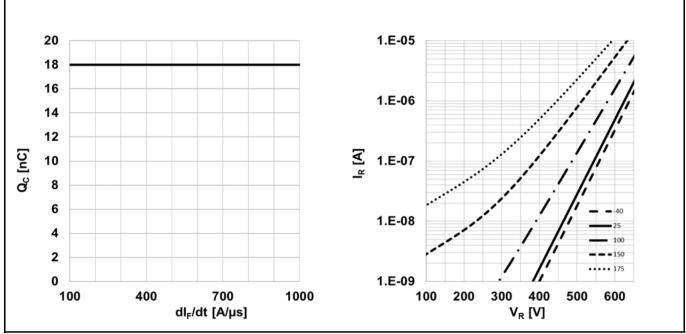
Figure 1

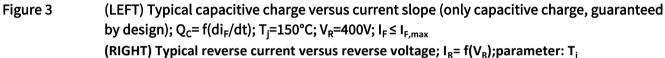
(LEFT) Power dissipation; $P_{tot} = f(T_C)$; $R_{thJC,max}$ (RIGHT) Diode forward current; $I_F = f(T_C)$; $T_i \le 175$ °C; $R_{thJC,max}$; parameter: D=duty cycle





Electrical Characteristics Diagrams





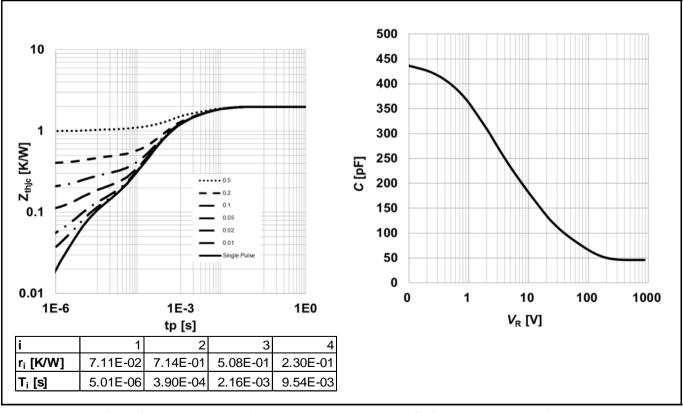


Figure 4

(LEFT) Max. Transient thermal impedance; $Z_{thJC} = f(t_P)$; parameter:D= t_P/T (RIGHT) Typ. Capacitance vs. Reverse voltage; C= $f(V_R)$; $T_i=25^{\circ}$ C; f=1 MHz



Electrical Characteristics Diagrams

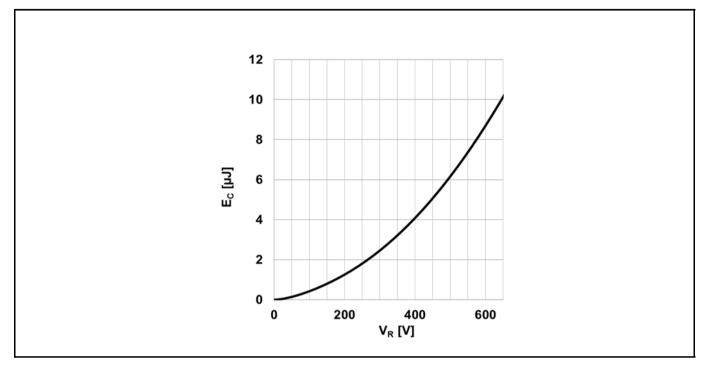
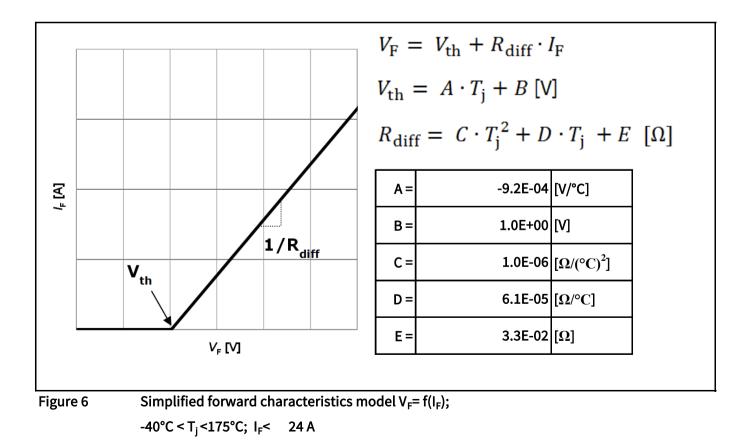


Figure 5 Typical capacitance stored energy; $E_c = f(V_R)$





Package Outlines

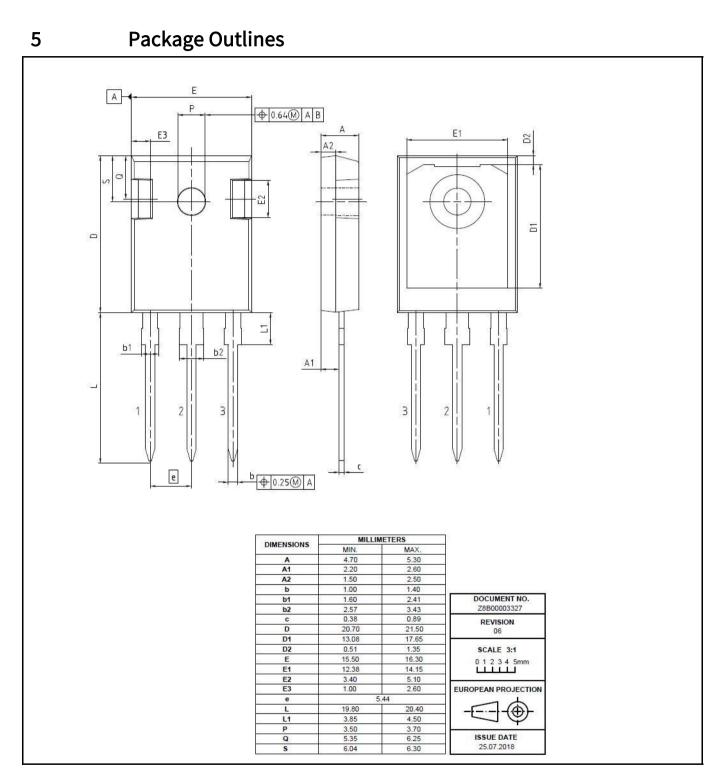


Figure 6

Package outline of PG-TO247-3-41 leaded (Dimensions in mm)



Revision History

Revision History

| Document Version | Date of Release | Description of changes | | | |
|---------------------|-----------------|---------------------------|--|--|--|
| V3.0 | 26.11.2018 | 1st release of Data Sheet | | | |
| | | | | | |
| | | | | | |
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